### Low-Power System Design

227-0781-00L Fall Semester 2019 Jan Beutel



## Plan for Today

- Introduction to the course theme
- Broad concepts and technology trends
- Logistics
  - Lecture
  - Reading/Writing Seminar
  - Hands-on Design Project
- Low-power system design opportunities
- Introduction to general terminology
- LP system architectures

### Masters Course at D-ITET

- Low-power System Design
  - Engineering course at master level
  - Not another circuit design class (with some low-power aspects)
  - Not purely software/algorithms or applications
  - Not only up-front teaching: discussions, hands-on project participation, time for questions
- Objective
  - Low-power and low-energy design techniques from a systems perspective
  - Aspects both from hard- and software
  - Technology oriented but focusing on the fundamentals
  - Cutting across a number of related areas
- Goals
  - Introduction to the state-of-the-art in research
  - Empowering students to ask relevant questions and develop ideas critically
  - Enable students to work on a research project of publishable quality

### What Makes These Perform So Well





### How to Evade Daily Battery Changes





### Why Power Is The Limit



## What is Power Management?

- Provisioning of energy for the required function in a timely manner
  - Availability of energy (volumetric)
  - Locality of energy (temporal, spatial)
  - Detrimental effects, e.g. excess heat production, cost of power and cooling, expensive materials
- Incentives for power management
  - Reduce overall energy consumption
  - Prolong battery life for portable and embedded systems
  - Reduce cooling requirements
  - Reduce noise
  - Reduce operating costs for energy and cooling
  - Cost of dark silicon



## **Energy-efficient Design Matters**

- 2014 Apple MAC mini vs. previous generation
  - 2x CPU performance
  - 1.65x graphics





### Recent Research on Energy-Efficiency Covers All Layers of System Design

#### eSENSE: Energy Efficient Stochastic Sensing Framework for Wireless Sensor Platforms ata Gathering in Sensor Networks Haiyang Liu, Abhishek Chandra and Jaideen Srivastava al yon Diekenhach Dagar Mattanhafar Dept. of Computer Science and E **Energy-Efficient Data Representation and Routing for** Minneapoli {hliu, chandra, sriv Wireless Sensor Networks Based on a Distributed Wavelet านเทนเทนเพียงอยู่เริ่มเออกเอนน Compression Algorithm ٦ Lucid Dreaming: Reliable Analog Event Detection for nio Ortega and Bhaskar Krishnamachari **Energy-Constrained Applications** tems, University of Southern California ilifornia. USA >ga@sipi.usc.edu, bkrishna@usc.edu Sasha Jevtic<sup>†</sup> Mathew Kotowsky<sup>‡</sup> Robert P. Dick<sup>†</sup> Peter A. Dinda<sup>†</sup> Charles Dowding<sup>\*</sup> stimized image Communication on sjevtic@eecs.northwestern.edu, {kotowsky, dickrp, pdinda, c-dowding}@northwestern.edu al Detection under the <sup>9</sup>latforms eless Sensor Networks <sup>‡</sup>Infrastructure Technology Inst. \*Civil & Environmental Engg. \*EECS Dept. Northwestern University Northwestern University Northwestern University nmad Rahimi<sup>2</sup> $or^{1}$ Energy-efficient Coverage for Target Detection in Wireless m a, Los Angeles ornia, Los Angeles Sensor Networks rsitv PA 18015 , Los Angeles mhr@cens.ucla.edu ehigh.edu Wei Wang, Vikram Srinivasan, Kee-Chaing Ch Power Scheduling for Wireless Department of Electrical and Computer Energy-efficient routing in wireless sensor networks {wang.wei,elevs,eleckc}@nus.edu.sg,wangb for delay sensitive applications D. Ranganathan, P. K. Pothuri, V. Sarangan, and S. Radhakrishnan NUCE UTIVE SILV Rice University Houston, Texas 77251-1892 Houston, Texas 77251-1892 crozell@rice.edu dhi@rice.edu



### Energy is on the Political Agenda





## Implications At The Societal Level

- Big topics of our days:
  - Sustainability
  - Climate Change
  - Sustainable Energy (Use)
  - Mobility



LEADERBOARD

VERSION 6: APRIL 2013

≁

≁

COOL

CISCO GOOGLE

ERICSSON

FUJITSU SPRINT WIPRO

IBM ALCATEL-LUCENT VODAFONE

> SOFTBANK MICROSOFT

## European Union Energy Label

- Energy labels are separated into at least four categories
  - Appliance's details
    - According to each appliance, specific details, of the model and its materials
  - Energy class
    - Color code giving an idea of the appliance's electrical consumption
  - Consumption, efficiency, capacity, etc. according to appliance type
  - Noise emitted by the appliance



### Example: The Incandescent Light Bulb

• An incandescent light bulb is an electric light which produces light with a wire filament heated to a high temperature by an electric current passing through it, until it glows. The hot filament is protected from oxidation with a glass or quartz bulb that is filled with inert gas or evacuated.



From Wikipedia

## Example: Light Bulb Evolution





From osram.com

### Energy Concerns Beyond System Operation

### Popular low-power "sales" arguments is limited to product usage

AT Smartphone Bench 2013: Web Browsing Battery Life (WiFi) Time in Hours - Higher is Better 10.27 Apple iPhone 5 HTC One X (AT&T) 9.93 8.53 Apple iPhone 4S Motorola RAZR i 7.88 7.68 HTC One X (International) 6.73 Motorola Droid RAZR M 6.3 Samsung Galaxy S 3 0

# The real energy footprint is much larger



From osram.com



### Research Trend: Building- Scale Energy Research (UCSD)

Electricity in the US

**ETH** *zurict* 

- Annual production: 4310 TWh, consumption: 3819 TWh in 2013
- Buildings require: 2,500 TWh, electronics inside: ~290 TWh
- Buildings consume significant amounts of energy
  - >70% of total US electricity consumption
  - >40% of total carbon emissions



### University Building Energy Breakdown



### Improving Energy Efficiency in Buildings

- 1. Reduce energy consumption by IT equipment
  - Servers and PCs left on to maintain network presence
  - Key Idea: "Duty-Cycle" computers aggressively
- 2. Reduce energy consumption by the HVAC system
  - Energy use is not proportional to number of occupants
  - Key Idea: Use real-time occupancy to drive HVAC
- Issues
  - "Always ON" abstraction of the Internet
  - Once turned OFF, how to turn back on?
  - Use models of user/application and infrastructure
  - Granularity of services/sensors

### In Practice: A Simple Source And Sink Was Yesterday



## Adding Software And Networking to Large-Scale Energy Systems

- Smart Grid
  - Leveraging information to improve efficiency, reliability, economics and sustainability in production, distribution and use of energy.



## Some Easy "Bedtime" Reading

### David JC MacKay

Regius Professor of Engineering in the Department of Engineering at the University of Cambridge and chief scientific adviser to the UK Department of Energy and Climate Change

- A physicists view on the present day global energy discussion
- Free book available online <u>http://www.withouthotair.com/</u>
- Short video
   David MacKay: A reality check on
   renewables. TEDx Warwick, March 2012.

https://www.ted.com/talks/david\_mackay\_ a reality check on renewables



### Renewable Energy At Scale



## New Applications: Environmental Monitoring using Wireless Sensor Networks



Hoernlihuette

Low-Power System Design

### **COURSE LOGISTICS**



### **Course Components**

- Goals of LPSD
  - Introduction to the state-of-the-art in research
  - Empowering students to ask relevant questions and develop ideas critically
  - Enable students to work on a research project of publishable quality
- Components
  - Up front lecture with slides (please make it interactive, ask questions)
  - Reading and writing seminar
  - Hands-on practical work, design project



### **Course Resources**

• Online course web page

https://www.tec.ee.ethz.ch/education/lectures/low-power-systemdesign.html

- Syllabus
- Reading material
- Assignments
- Links to further resources
- Updates to material as we progress
- Riot chat room for reading seminar: <u>#lpsd:matrix.ee.ethz.ch</u>
  - Submitting reviews
  - Discussion
  - Sharing of other related papers, interesting stuff
  - Questions/Answers
- In case of questions: janbeutel@ethz.ch

### Lecture Schedule

| Week | Date       | Lecture Wednesday 10-12h                                   | Lab Exercises Wednesday 13-15h          |
|------|------------|--|---|
| 1    | 18.09.2019 | Lecture 1 - Course Introduction, Definitions, Metrics      | Reading/Writing Seminar Introduction    |
| 2    | 25.09.2019 | Lecture 2 - LP System Architectures                        | Lab 1                                   |
| 3    | 02.10.2019 | Lecture 3 – LP System Architectures                        | Lab 2                                   |
| 4    | 09.10.2019 | No Lecture - Reading Seminar only                          | Lab 3                                   |
| 5    | 16.10.2019 | No Lecture - Reading Seminar only                          | Lab 4                                   |
| 6    | 23.10.2019 | Lecture 4 – Networked Embedded Systems                     | Intro Design Project                    |
| 7    | 30.10.2019 | Lecture 5 – Networked Embedded Systems                     | Technical Support for Design Project    |
| 8    | 06.11.2019 | Lecture 6 – Networked Embedded Systems                     | Technical Support for Design Project    |
| 9    | 13.11.2019 | Lecture 7 - Networked Embedded Systems                     | Technical Support for Design Project    |
| 10   | 20.11.2019 | Lecture 8 - Modeling, Tools and Methods for Power Analysis | Technical Support for Design Project    |
| 11   | 27.11.2019 | Lecture 9 - Modeling, Tools and Methods for Power Analysis | Technical Support for Design Project    |
| 12   | 04.12.2019 | Lecture 10 - Renewable Energy                              | Technical Support for Design Project    |
| 13   | 11.12.2019 | Lecture 11 - Renewable Energy                              | Technical Support for Design Project    |
| 14   | 18.12.2019 | Lecture 12 - Project Presentations                         | Student Presentations of Design Project |

## **Daily Synopsis**

- Lecture (~60-75 min)
  - Recap last lecture, introduce structure of topics & objective of today's lecture
  - Daily lecture
  - Feed in a daily
    - Hot research topic/paper of the day
    - Prominent research figure in the area
    - Practical example (success story or failure)
  - Recap objective of the day
- Reading and Writing Seminar (~30 min)
  - Short presentation by group of students
  - Discussion of papers
  - Introduce reading for next week
- Exercises, Lab and Reading Time (2x 45 min)
  - Dual Processor Platform (DPP) on loan for everyone
  - Introduction to DPP platform & FlockLab testbed
  - DPP tutorial support
  - Small design project in groups of 2-3 over whole length of the course

## Reading and Writing Seminar

- Reading assignment of 1 paper per week **until FRIDAY** 
  - 2-3 students prepare a written summary (max. 200-300 words)
    - Write-up should contain the (i) essential points of the paper, (ii) it's main contribution and (iii) your assessment
    - Research of related work: recent papers, different approaches, historical background...
  - Summary is shared with all via discussion forum (matrix chatroom)
- Discussion/questions/comments FRIDAY to WEDNESDAY
  - EVERYBODY comments on review summary and paper
    - Your own opinion
    - Corrections/additions to the reviewers voice
    - Additional questions
  - Joint search for related work, interesting ecosystem etc.
- Joint discussion of papers in class WEDNESDAY in class
  - Short presentation of paper and summary in class to kick off discussion
  - Presentation using max. 3-4 slides (not a full paper presentation)
- Reading/writing and your contributing to the discussions is part of the grade (30%)
- Assignment via signup sheet with
  - 1x summary write-up/paper presentation
  - 4x review/commenting per student

## Hands-on Practical Design Project

• Design project using Dual Processor Platform (DPP)



- In groups (of 2-3) develop a low-power application
  - Introduction to state-of-the-art tools
  - Effective power consumption effects should be visible
  - Focus on aspects of dynamic range
- Presentation and discussion of results in final lecture
- Tournament: Best team is awarded a prize

## **Resources for Hands-on**

- Dual-Processor Platform
  - State-of-the-Art Sensor network platform
  - ETH-built...



DPP2 SX1262 ComBoard ST STM32L433CC, 256k ROM, 64k SRAM, 80 MHz RAM2 (16 KiB) has option for retention 0.28 µA (standby with RTC), 7 µs wakeup from stop mode -148 dB at (SF12, 125 kHz), 389 mW at +22 dB m LoRa, GFSK

#### **ETH** zürich

**STM**32

·80 mm

**Cube**MX

### **Resources for Hands-on**

| Arm® Cortex®-M4 (DSP + FPU) - 80 MHz |  | STM32 L4<br>Product line                   | Flash<br>(KB)  | ram<br>(KB) | Memory<br>I/F<br>FSMC | Op-Amp | CAN   | Sigma Delta<br>Interface | 12-bit ADC<br>5 Msps<br>16-bit HW<br>oversampling | DAC | SM | USB2.0 OTG FS | USB Device | Segment<br>LCD driver | Chrom-ART<br>Accelerator <sup>TM</sup> |
|--------------------------------------|--|--|----------------|-------------|-----------------------|--------|-------|--------------------------|---|-----|----|---------------|------------|-----------------------|--|
|                                      |  | STM32L4x6 - USB 0TG + Segment LCD Lines    |                |             |                       |        |       |                          |   |     |    |               |            |                       |  |
|                                      | ART Accelerator™     USART, SPI, I <sup>2</sup> C                                | STM32L496**                                | 512<br>to 1024 | 320         |                       | 2      | 2     | 8x ch                    | 3   | 2   | 2  | •             |            | Up to<br>8x40         | •                                      |
|                                      |  | STM32L476*                                 | 256<br>to 1024 | 128         | •                     | 2      | 1     | 8x ch                    | 3   | 2   | 2  | •             |            | Up to<br>8x40         |  |
|                                      | Quad-SPI   | STM32L4x5 - USB OTG lines                  |                |             |                       |        |       |                          |   |     |    |               |            |                       |  |
|                                      | 16- and 32-bit timers     SAI + audio PLL  | STM32L475                                  | 256<br>to 1024 | 128         | •                     | 2      | 1     | 8x ch                    | 3   | 2   | 2  | •             |            |                       |  |
|                                      | • SWP  | STM32L4x3 - USB Device + Segment LCD lines |                |             |                       |        |       |                          |   |     |    |               |            |                       |  |
|                                      | 2x CAN     2x 12-bit DACs     Temperature sensor                                 | STM32L433*                                 | 128<br>to 256  | 64          |                       | 1      | 1     |                          | 1   | 2   | 1  |               | •          | Up to<br>8x40         |  |
|                                      | Low voltage 1.71 to  | STM32L4x2 - USB Device lines               |                |             |                       |        |       |                          |   |     |    |               |            |                       |  |
|                                      | 3.6 V<br>• V <sub>Bar</sub> mode<br>• Unique ID<br>• Capacitive touch<br>sensing | STM32L452*                                 | 256<br>to 512  | 160         |                       | 1      | 1     | 4x ch                    | 1   | 1   | 1  |               | •          |                       |  |
|                                      |  | STM32L432*                                 | 128<br>to 256  | 64          |                       | 1      | 1     |                          | 1   | 2   | 1  |               | •          |                       |  |
|                                      | <ul> <li>AES-120/256"<br/>and SHA-256**</li> </ul>                               | STM32L412*                                 | 64<br>to 128   | 40          |                       | 1      |       |                          | 2   |     |    |               | •          |                       |  |
|                                      |  |  |                |             |                       | ST     | M32L4 | x1 - Acce                | ss lines  |     |    |               |            |                       |  |
|                                      |  | STM32L471                                  | 512<br>to 1024 | 128         | •                     | 2      | 1     | 8x ch                    | 3   | 2   | 2  |               |            |                       |  |
|                                      |  | STM32L451                                  | 256<br>to 512  | 160         |                       | 1      | 1     | 4x ch                    | 1   | 1   | 1  |               |            |                       |  |
| a                                    |  | STM32L431                                  | 128<br>to 256  | 64          |                       | 1      | 1     |                          | 1   | 2   | 1  |               |            |                       |  |

Note: \* HW crypto/hash functions are available on STM32L486, STM32L443, STM32L462, STM32L442 and STM32L422 - \*\* on STM32L4A6

## Resources for Hands-on

- DPP dev-board on loan for everyone for duration of semester
- FlockLab Testbed
  - Testbed of 30+ nodes
  - Remote programming of nodes
  - Testing of applications in larger networks
  - Power profiling, digital tracing/actuation
- FlockLab is a shared/limited resource
  - Only one user active per time slice
  - Need to accommodate everyone
- Cooja Simulator support
- Support through online forums and TA's
  - Roman Trueb <u>roman.trueb@tik.ee.ethz.ch</u>
  - Matthias Meyer <u>matthias.meyer@tik.ee.ethz.ch</u>
  - Reto Da Forno <u>reto.daforno@tik.ee.ethz.ch</u>



http://www.flocklab.ethz.ch/

## Grading

- Official announcement
  - 30% contributions to the reading/writing seminar
  - 70% oral exam
- Hands-on design project
  - A successful design project will count positive towards the oral exam grade
  - Part of the oral exam will review your proposed solution and the concepts underlying the implementation

### Some Comments

- Course will mean quite some work for you.
- Reading takes some time. Use Wednesday afternoons.
- Will shift around timing as needed.
- Also we can discuss your topics/questions as needed.
- Hands-on design project was very successful in past years
  - Depends on your own laptop infrastructure
  - Need to share resources on FlockLab testbed
  - Requires you to plan ahead (not just a last minute effort)

## Timeout

- What do you want to learn about low-power system design?
- Your expectations?
- Your backgrounds?




## LOW-POWER SYSTEM DESIGN OPPORTUNITIES

Low-Power System Design

### What's Inside & Makes It Tick So Well?





#### Inside an iPhone5



From ifixit.com

# What's Inside an iPhone5?

- How many
  - CPU's + Storage?
  - Wireless radios?
  - Wireless
    amplifiers/peripherals?
  - Sensors?
  - Peripherals?
  - Power management?









# What's Inside an iPhone5?

- CPU's + Storage
  - Apple A6 339S0177 Application Processor. (2x ARM, 3x GPU)
  - Elpida 1 GB LPDDR2 DRAM
  - Hynix H2JT0G8UD2MBG NAND Flash. 16 GB
  - Qualcomm MDM9615 4G LTE processor + Samsung 1Gb DRAM memory
- Wireless radios
  - . CDMA (800, 1900, 2100 MHz)
  - UMTS/HSPA+/DC-HSDPA (850, 900, 1900, 2100 MHz)
  - GSM/EDGE (850, 900, 1800, 1900 MHz)
  - LTE (+ GPS)
  - 802.11a/b/g/n Wi-Fi (2.4GHz, 5GHz) + Bluetooth 4.0
- Wireless amplifiers/peripherals
  - Skyworks 77352-15 GSM/GPRS/EDGEPower Amplifier Module
  - Skyworks 77491-15B Power Amplifier Module
  - Avago AFEM 7813 Power Amplifier Module
  - Avago ACPM-5613 LTE band 13 Power Amplifier
  - Skyworks 70631 LNA
  - Triquint 666083-1229 WCDMA / HSUPA power amplifier / duplexer module
  - Murata module D06 with Peregrine DP12T RF Switch
  - . Murata module SWUA147
  - RF Micro RF1101 Hi-Power SPDT Switch .
  - RF Micro RF1102 Antenna Tuning Module
  - Qualcomm MDM9615 LTE Processor .
  - PM8018 RF Power Management
  - Murata 339S0171 WiFi module
  - Qualcomm RTR8600

#### Sensors

- STMicroelectronics L3G4200D 3 Axis gyro. .
- STMicroelectronics LIS331DLH (2233/DSH/GFGHA) three axes accelerometer
- **OmniVision Camera 1.2Mp**
- Sony Camera 8 Mp
- Peripherals
- Apple 338S1077 Audio CODEC
- Apple 338S1117 Cirrus Audio Chip
- Texas Instruments 27C24S1 / 343S0628 touch screen controller
- BCM5976 trackpad controller
- - Apple 338S1131 Power Management IC







- The underside of the logic board is teeming with components.
- Skyworks 77352-15 GSM/GPRS/EDGE power amplifier module
- SWUA 147 228 is an RF antenna switch module
- Triguint 666083-1229 WCDMA / HSUPA power amplifier / duplexer module for the UMTS band
- Avago AFEM-7813 dual-band LTE B1/B3 PA+FBAR duplexer module
- Skyworks 77491-158 CDMA power amplifier module
- Avago A5613 ACPM-5613 LTE band 13 power amplifier



Step 15

#### Edit つ

Edit 🗔

- More chips on the underside of the logic board:
- Qualcomm PM8018 RF power management IC
- Hynix H2ITDG2MBR 128 Gb (16 GB) NAND flash
- Apple 33851131 dialog power management IC\*
- Apple 33851117 Cirrus Logic Class D Amplifiers. The die inside is a Cirrus Logic device (second image) but it does not look like the audio codec.
- STMicroelectropics I 364200D (AGD5/2235/G85BI ) low-power three-axis gyroscope-same as seen in the iPhone 45, iPad 2, and other leading smart phones
- Murata 33950171 Wi-Fi module
- Chips on a board. Kinda like ants on a log.
- STMicroelectronics LIS331DLH (2233/DSH/GFGHA) ultra low-power, high performance, three-axis linear accelerometer
- Texas Instruments 27C245I touch screen SoC
- Broadcom BCM5976 touchscreen controller
- Rather than a single touchscreen controller. Apple went with a multichip solution to handle the larger screen size, à la iPad.
- Apple A6 application processor
- Qualcomm MDM9615M LTE modem
- Oualcomm RTR8600 Multi-band/mode RF transceiver, the same one found in the Samsung Galaxy S III

From ifixit.com









### In Comparison – 1<sup>st</sup> Generation iPhone

- Dual board stack
  - 620 MHz ARM + 512 MB DRAM stacked chip
  - WLAN + Bluetooth
  - SIM card holder
- Solder on battery pack
  - 3.7V@1400mAh Li-Ion Polymer







# Where Does the Energy Go?





# System Design Options



# **Broad Technology Trends**

# **Moore's Law:** # transistors on cost-effective chips doubles every 18 months





- Today: millions of transistors per \$
- Same fabrication technology provides CMOS radios for communication and micro-sensors
- Efficiency and leakage improvements at similar scale

### **Battery Improvements are Slow**



**ETH** zürich

Slow increase in capacity: ~8% per year (Wh/cm^3)

# Powering the Performance Increase



#### Cellular Talk Time Time in Hours - Higher is Better

| Motorola Droid RAZR MAXX          |       |    |    | 20 | .84 |  |
|-----------------------------------|-------|----|----|----|-----|--|
| HTC One X (International)         |       |    |    |    |     |  |
| Motorola Droid 4                  |       |    |    |    |     |  |
| Samsung Galaxy Nexus (GSM/UMTS) 📃 | 11.15 |    |    |    |     |  |
| HTC One S (T-Mobile)              | 11.11 |    |    |    |     |  |
| HTC One V                         |       |    |    |    |     |  |
| HTC One X (AT&T)                  | 10.73 |    |    |    |     |  |
| Samsung Galaxy S II               | 10.64 |    |    |    |     |  |
| Samsung Galaxy S III AT&T 💻       | 10.48 |    |    |    |     |  |
| HTC Rezound                       |       |    |    |    |     |  |
| HTC EVO 4G LTE                    |       |    |    |    |     |  |
| Apple iPhone 4S                   |       |    |    |    |     |  |
| Apple iPhone 5                    |       |    |    |    |     |  |
| Lava XOLO X900                    |       |    |    |    |     |  |
| Google Nexus S                    |       |    |    |    |     |  |
| Samsung Galaxy S 4G               |       |    |    |    |     |  |
| Apple iPhone 4                    | 7     |    |    |    |     |  |
| Google Nexus One                  | 6.    |    |    |    |     |  |
| Samsung Galaxy S II T-Mobile      | 6.3   |    |    |    |     |  |
| Samsung Galaxy S II Skyrocket     | 5.82  |    |    |    |     |  |
| Apple iPhone 3GS                  | 4.82  |    |    |    |     |  |
| 0                                 | 5     | 10 | 15 | 20 | 2   |  |



#### **Batteries Use Up Most Space**





### Evolution 1.0 – Removable Packs





#### Higher Packing Density – Segmentation





# Latest – Glue-in Gel Pack Batteries



#### Integration Density

- iPad 2: 25Wh
- iPad 3: 42.5Wh

#### Technology Push

– iPhone 4S

3.7V @ 1432mAh = 5.3Wh Talk time: Up to 8 hours Standby: Up to 200 hours.

#### – iPhone 5

3.8V @ 1440mAh = 5.45Wh Talk time: Up to 8 hours Standby: Up to 225 hours



#### **Storage Hierarchies Using Supercapacitors**



**ETH** zürich

Figure 6 A rule of thumb for equilibrium-leakage-current CAP-XX supercapacitors at room temperature is 1 µA/F.

### Unexpected Opportunities for Energy Improvements at System Level





# A More Energy Efficient Display

- Removal of display backlight
- Addition of white pixels
- RGBW subpixel rendering
  - Better image control
  - More contrast for outdoor viewing

Sample Sample

Significant power savings



### Leveraging Ambient Energy Sources: Miniaturized Zero-Power Systems



**EH**zürich

#### Largest Gains – Power Aware Software

| ¥ (    | 1              |         | } | _{ <b>\ \G</b> Ë<br> | al 🛃 | 12:17   |
|--------|----------------|---------|---|----------------------|------|---------|
|        | Plot           |         |   | 2 Ho                 | ours |         |
|        | 10:30pm        | 11:00pm |   | 11:30pm              |      | 12:00am |
| Chargi | ng             |         |   |                      |      |         |
| 100%   |                |         |   |                      |      |         |
| 75%    |                |         |   |                      |      |         |
| 50%    |                |         |   |                      |      |         |
| Batter | y Charge       |         |   |                      |      |         |
|        | 10:30pm        | 11:00pm |   | 11:30pm              |      | 12:00am |
| 100%   |                |         |   |                      |      |         |
| 75%    |                |         |   |                      |      |         |
| 50%    |                |         |   |                      |      |         |
| 25%    |                |         |   |                      |      |         |
| Device | Usage (Display | On)     |   |                      |      |         |
| 100%   |                |         |   |                      |      |         |
| 75%    |                |         |   |                      |      |         |
| 50%    |                |         |   |                      |      |         |
| ł      | Live           |         |   | Hist                 | ory  |         |



Low-Power System Design

#### **GENERAL TERMINOLOGY**



# Power and Energy

• Energy is a property of objects.

SI unit for energy = joule [J]

 $1 \text{ J} = 1 \text{ N} \cdot \text{m} = 1 \text{ kg} \cdot \text{m} 2/\text{s} 2 = 1 \text{ V} \cdot \text{C} = 1 \text{ W} \cdot \text{s}$ 

In engineering the unit of energy is the watt-hour [Wh]  $1 J = 1 W \cdot s = 2.7 \times 10^{-4} W \cdot h$  $1 W \cdot h = 3600 J$ 

• Energy is our limited resource, and power is the rate at which we consume (or replenish) that resource.

SI unit for power = watt [W]

$$1 W = 1 J/s = V \cdot C/s = V \cdot A$$



### **Electric Power**

• Electric potential energy = charge x voltage

$$U = Q \cdot V$$

- Remember power is the rate of doing work
- Electrical power equals energy/per unit time

$$P = \frac{U}{t} = \frac{QV}{t} = V \cdot I$$

**Q:** How much energy does a 1-watt system consume per second/per hour?



### **Power Consumption**

• In most circuits, the power supply voltage is constant. In circuits where the current varies with time, we must make a distinction between **instantaneous power** and **average power**.



# Dynamics of Power and Energy



 In some cases, faster execution also means less energy, but the opposite may be true if power has to be increased to allow for a faster execution.

# **Power and Efficiency**

• The **efficiency** of is defined as useful power output divided by the total electrical power consumed.

 $\eta = \frac{\textit{Useful power output}}{\textit{Total power input}}$ 

 Performance-per-watt is a typical to describe energy efficiency in computing hardware.





# Low Power vs. Low Energy

- Minimizing the *power consumption* is important for
  - the design of the power supply and voltage regulators
  - the dimensioning of interconnect between power supply and components
  - cooling (short term cooling)
    - high cost
    - limited space
- Minimizing the *energy consumption* is important for
  - restricted availability of energy (mobile systems)
  - limited battery capacities (only slowly improving)
  - very high costs of energy (energy harvesting, solar panels)
  - long lifetimes, low temperatures

# Where Does Power Go in CMOS?

- Dynamic Power Consumption
  - Charging and discharging capacitors
- Short Circuit Currents
  - Short circuit path between supply rails during switching
- Leakage
  - Leaking diodes and transistors
- Most of it is thermal energy in the end
- Countermeasures
  - Prime choice: Reduce voltage!
  - Reduce switching activity
  - Reduce physical capacitance





# Where Does Power Go in CMOS?



# Low-Power Hardware Design Rules

- Reduction of dynamic power
  - $\alpha$ : clock gating, sleep modes
  - C: small transistors (esp. on clock), short wires
  - V<sub>dd</sub>: lowest suitable voltage
  - f: lowest suitable frequency

 $P_{dyn} = \alpha f C + V^2 f$ 

flexible fix

fixed by project

- Main application: DVFS (Dynamic Voltage and Frequency Scaling)
  e.g. Intel Core/Xeon, ARM cores, multiprocessor systems...
- Reduction of static power
  - Power gating
  - Selectively use ratioed circuits (weak pull-up and strong pull-down)
  - Selectively use low V<sub>t</sub> devices
  - Leakage reduction: stacked devices, body bias, low temperature

# **Reduction of Switching Activity**

- Primary mean in LP systems is **duty cycling** of subsystems
  - Dynamic voltage scaling and dynamic frequency scaling is a typical technique to reduce CPU power consumption.
- A **duty cycle** is defined as the ratio between activity and the period given as percentage.

$$D = \frac{T}{P} * 100\%$$



- Obvious impact on system performance
  - Throughput
  - Latency
  - Reactivity

### Dynamic Power Management (DPM)

- Dynamic power management tries to assign optimal power saving states during program execution
- DPM requires hardware and software support





Example: StrongARM SA1100

### Example: Low Power States in uC



### **Dynamic Power Management**



# Modelling Low Power State Changes



- The energy saving on entering a sleep mode is  $E_{saved} = (t_{event} - t_1)P_{active} - \frac{\tau_{down}(P_{active} + P_{sleep})}{2} + (t_{event} - t_1 - \tau_{down})P_{sleep}$
- With the overhead

$$E_{overhead} = \frac{\tau_{up}(P_{active} + P_{sleep})}{2}$$

• This is only beneficial if  $E_{overhead} < E_{saved}$  or

$$(t_{event} - t_1) > \frac{1}{2}(\tau_{down} + \frac{P_{active} + P_{sleep}}{P_{active} - P_{sleep}}\tau_{up})$$

# Examples: Duty-Cycle Operation


# Dynamic Range Exceeds 10,000:1

|                 |                 |              |  |   |          |   |          | Energy Sink        | Power State        | Current     |
|-----------------|-----------------|--------------|--|---|----------|---|----------|--------------------|--------------------|-------------|
|                 |                 |              |  |   |          |   |          | Microcontroller    |                    |             |
|                 |                 |              |  |   |          |   |          | CPU                | ACTIVE             | $500 \mu A$ |
|                 |                 |              | CDF of   | P-State                                       | Drawe    |   |          |                    | LPM0               | 75 µA       |
|                 |                 |              |  | -otate  | Diaws    |   |          |                    | LPM1 <sup>†</sup>  | 75 µA       |
|                 | 1               |              |  |   |          | 111111                                  | <b></b>  |                    | LPM2               | 17 µA       |
|                 |                 |              |  |   |          |   | I        |                    | LPM3               | 2.6 µA      |
|                 | 00              |              |  |   | > 5      | $0 \mathbf{m} \mathbf{W}$               | ¥        |                    | LPM4               | $0.2 \mu A$ |
|                 | 0.9             |              |  |   |          |   | *        | Voltage Reference  | ON                 | $500 \mu A$ |
|                 |                 |              |  |   |          |   |          | ADC                | CONVERTING         | $800 \mu A$ |
|                 | 00              |              |  |   |          | , i i i i i i i i i i i i i i i i i i i |          | DAC                | CONVERTING-2       | 50 µA       |
| ion of P-States | 0.0             |              |  |   |          | *                                       |          |                    | CONVERTING-5       | $200 \mu A$ |
|                 |                 |              |  |   |          | Ž.                                      |          |                    | CONVERTING-7       | $700 \mu A$ |
|                 |                 |              |  |   |          |   |          | Internal Flash     | PROGRAM            | 3 mA        |
|                 | 0.7             |              |  |   |          | *                                       |          |                    | ERASE              | 3 mA        |
|                 |                 |              |  |   |          | f                                       |          | Temperature Sensor | SAMPLE             | $60 \mu A$  |
|                 | 0.6             |              |  |   |          |   |          | Analog Comparator  | COMPARE            | 45 µA       |
|                 | 0.0             |              |  |   | ¥~~      |   |          | Supply Supervisor  | ON                 | 15 µA       |
|                 | 1000 10000      |              |  |   | ×        |   |          | Radio              | OFF                |             |
|                 | 0.5             |              |  |   | - I - I  |   |          | Regulator          | OFF                | $1 \mu A$   |
|                 |                 |              |  |   |          |   |          |                    | ON<br>DOWER DOWN   | $22 \mu A$  |
|                 | ~ 1             |              |  |   |          |   |          | Detter Meriter     | POWER_DOWN         | 20 µA       |
|                 | 0.4             |              |  | I III   |          |   |          | Gantral Dath       | ENABLED            | 50 µA       |
| *               |                 |              |  | <pre>/</pre>                                  |          |   |          | Pr Data Dath       | DLE<br>DV (LISTEN) | 420 µA      |
| ğ               | 0.2             |              |  | <b>∮</b>                                      |          |   |          | Tx Data Path       | TX (10 dBm)        | 19.7 mA     |
| 2               | 0.3             |              |  |   |          |   |          | IX Data Fatti      | TX (+0  dBm)       | 16.5 mA     |
| ш               |                 |              |  | 4   |          |   |          |                    | TX (-1  ubm)       | 15.2 mA     |
|                 | $\cap 2$        |              |  | *   |          |   |          |                    | TX (-5 dBm)        | 13.2 mA     |
|                 | 0.2             |              |  | 7   |          |   |          |                    | TX (-7 dBm)        | 12.5 mA     |
|                 |                 |              |  | <u>,                                     </u> |          |   |          |                    | TX (-10  dBm)      | 11.2 mA     |
|                 | 01-5            | 1 UVV        | and the second s |   |          |   |          |                    | TX (-15 dBm)       | 9.9 mA      |
|                 | 0.1             |              |  |   |          |   |          |                    | TX (-25 dBm)       | 8.5 mA      |
|                 |                 | ******       |  |   |          |   |          | Flash              | POWER_DOWN         | 9 µ A       |
|                 | 0               |              |  |   |          |   | _ لننتنت |                    | STANDBY            | 25 µA       |
|                 | $10^{-1}$       | $10^{\circ}$ | $10^{1}$   | $10^{2}$                                      | $10^{3}$ | 10 <sup>4</sup>                         | $10^{5}$ |                    | READ               | 7 mA        |
|                 |                 |              | <b>D</b>   |   | ( 140    | 1.0                                     | 10       |                    | WRITE              | 12 mA       |
|                 | Power Draw (µW) |              |  |   |          |   |          |                    | ERASE              | 12 mA       |
|                 |                 |              |  |   |          |   |          | LED0 (Red)         | ON                 | 4.3 mA      |
|                 |                 |              |  |   |          |   |          | LED1 (Green)       | ON                 | 3.7 mA      |
|                 |                 |              |  |   |          |   |          | LED2 (Blue)        | ON                 | 1.7 mA      |

# Radio Power Budget Basics

 Free-space path loss according to Friis equation

$$P_r = P_T G_T G_R \left(\frac{\lambda}{4pid}\right)^2$$

 Exponent depends on environment

**ETH** zürich

- Free space 2
- Urban cellular 2.7-3.5
- Indoor typical 3-4
- Indoor worst case 4-6
- Multi-hop networking reduces demand in TX power considerably

### A typical multi-hop system example



R. Szewczyk, A. Mainwaring, J. Polastre, D. Culler, "An Analysis of a Large Scale Habitat Monitoring Application", ACM SenSys' 04, November, 2004.

 Idle listening dominates the power budget even at radio duty cycles of just 1 to 2%

## Therefore, the radio is kept mostly off

## Low-Power Listening





Overhearing adds significant unpredictability to node lifetime

# Today's Hot Researcher & Paper

- Mark Weiser (1952-1999)
  - Chief scientist at Xerox PARC in the US
  - Considered to be the father of ubiquitous computing

"Ubiquitous computing names the third wave in computing, just now beginning. First were mainframes, each shared by lots of people. Now we are in the personal computing era, person and machine staring uneasily at each other across the desktop. Next comes ubiquitous computing, or the age of calm technology, when technology recedes into the background of our lives."

-Mark Weiser

 Mark Weiser: "The Computer for the 21st Century" -Scientific American Special Issue on Communications, Computers, and Networks, September, 1991



# Weisers Ubicomp Vision



# The Evolution of Weiser's Idea

InfoPad

[UC Berkeley 1999]



PARC Tab and PARC Pad

#### [XEROX PARC 1988-1995]







Tablet 2014

# Recap of Today

- Lowering the energy footprint of systems is an increasingly important topic.
- Apart from using advances in modern LP hardware good system design and software support are crucial. This requires a system view.
- Increasing demand for networked interactions, mobility and constant availability complicate system design.

## **Energy-efficiency affects all layers of system design.**



# Recap of Today

- **Power** is defined as the rate of **energy transfers**.
- It is required to differentiate between instantaneous and average power consumption.
- Low-power wireless systems are **highly resource constrained**.
- Limited energy availability is the main resource obstacle.
- In order to prolong functionality **power management** e.g. by duty-cycling is necessary. This introduces **further complexity** to the system (design).